





Cross nozzles (page 33)

DEPARTMENTS

	AEI NEWS	8
0	IN VIEW THIS MONTH	55
	BUSINESS STRATEGY	56
W/	COMPANY ON THE MOVE	60
	PRODUCT NEWS	64

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NEPCON CHINA 2018

Smart Factory 1.0 Debuts in NEPCON China	_ 10
Japan Unix	_ 12
Tokyo Weld	_ 14
JUKI	_ 16
FUJI	_ 22
Yamaha Motor	_
SMIC	_ 33
TECH FOCUS	
New Energy-Related Fields Attract Component Makers	_ 36
Quantification of Electron Scattering Lowers	
Resistance of SiC Power ICs	_ 38
High-Power Flexible Thermoelectric Module Makes Use of Waste Heat	30
Street Lighting Lies at Heart of Smart City Infrastructure	
SMT's: IN REVIEW	_ 43
COMPONENT MATERIALS	_ 44
TEST AND MEASUREMENT	_ 46
TECHNOLOGY HIGHLIGHT	
On-Chip Color Filters Evolve with Image Sensor	
Development	_ 47
Stable MIS GaN Power Transistor Unlocks Ultrafast Power Device	49
	T /
PRODUCT HIGHLIGHT	
JAE Augments USB Type-C Products with Cable Harness	_ 50
INDUSTRY REPORT	
Japanese Electronic Parts Makers Focus on Next	
Growth Phase	_ 51
Capacitor Manufacturers Put Emphasis on Hybrid Varieties	_ 52
ZOOM-IN	
SIIQ Spurs Promotion of Semiconductors,	
Touts Alliance as Key	_ 54
TOP INTERVIEW	
Nihon Denkei Focuses on Automotives,	=-
Opens CMS Test Facility in Japan	_ 58
SHOW PREVIEW	
PCB Thailand 2018	
INATRONICS 2018	62